High performance sensor interfaces: Efficient system architectures and calibration techniques

Marc Pastre – 2011

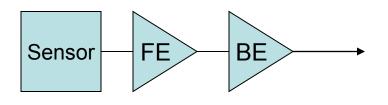


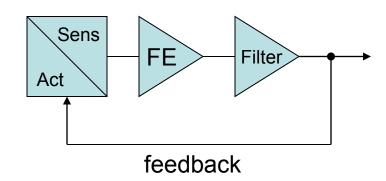
Outline

- Sensor interfaces
 - System architectures
 - Open-loop vs. Closed-loop
 - Continuous-time vs. Sampled
 - Frontends
 - Voltage-, current-, charge-mode
- Case studies
 - Hall sensor
 - MEMS-based accelerometer
- Digital calibration
 - Successive approximations
 - M/2⁺M Sub-binary DACs for successive approximations
- Conclusion



Open-loop vs. Closed-loop





- Straightforward implementation
- Analog output
- Sensitive to sensor non-linearity

- Directly compatible with a $\Delta\Sigma$ loop
- Digital or analog output
- Insensitive to sensor non-linearity
- Sensitive to actuator non-linearity
- Feedback loop stability
- Bandwidth



Continuous-time vs. Sampled systems

- Continuous-time:
 - Straightforward
 - Low power consumption
 - High bandwidth
 - Not really compatible with continuous-time calibration
- Sampled systems directly compatible with:
 - Closed-loop $\Delta\Sigma$ modulators
 - Switched capacitor circuits
 - Digital calibration



Voltage-, current-, charge-mode

Voltage-mode:

- Hi-Z ⇒ Instrumentation amplifier, Op-Amp (+ input)
- Low-Z ⇒ Op-Amp circuit, switched capacitor

Current-mode:

- Transimpedance amplifier
 (based on common-source transistor, Op-Amp, ...)
- Switched capacitor circuit used as integrator
- Virtual ground @ input

Charge-mode:

- Transimpedance integrator
 (based on common-source transistor, Op-Amp, ...)
- Switched capacitor



Case studies

- Hall sensor microsystem:
 - Open-loop
 - Voltage-mode
 - Sampled
 - Continuous-time sensitivity calibration
- MEMS-based accelerometer:
 - Closed-loop
 - Voltage-/Charge-mode
 - Sampled
 - Sensor included in a $\Delta\Sigma$ loop



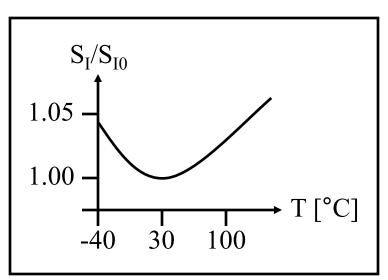
Hall sensor microsystem

- Continuous-time sensitivity calibration
- Reference field generated by integrated coil
- Combined modulation scheme mixes up reference and external signal
- Parallel demodulation schemes allow continuous background sensitivity calibration
- Compensation of any cause of drift (temperature, mechanical stresses, ageing)

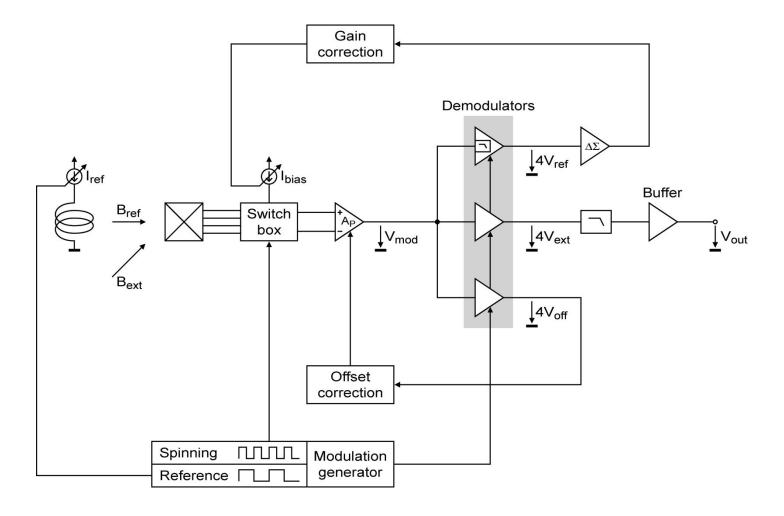


Sensitivity drift of Hall sensors

- Drift due to
 - Temperature
 - Mechanical stresses
 - Ageing
- Typical temperature drift
 - 500 ppm/°C uncalibrated
 - 300 ppm/°C with 1st order correction
- Typical ageing drift
 - 20'000 ppm (2 %)

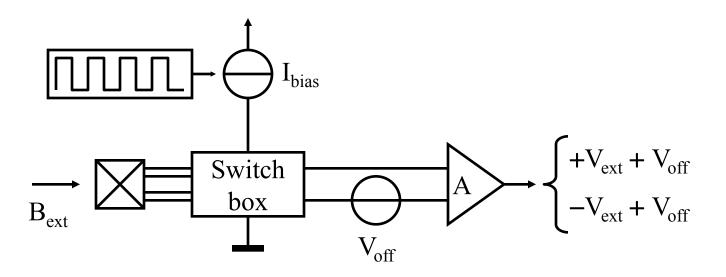


System architecture





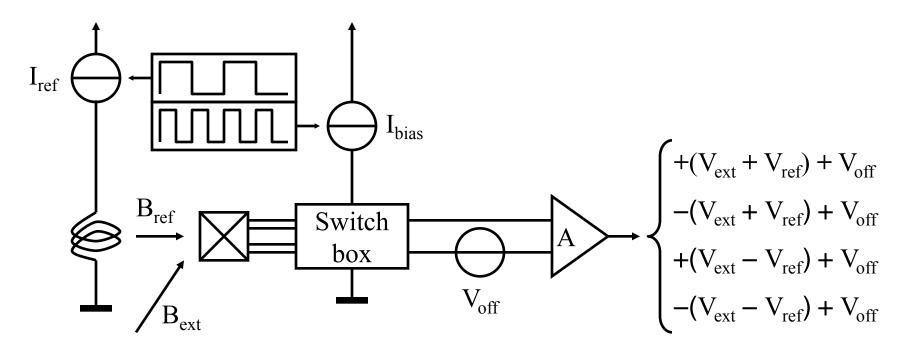
Spinning current modulation



- 2 modulation phases
- Modulated signal, constant offset
- Offset-free signal extracted by demodulation



Combined modulation



- 4 modulation phases
- Modulated signal & reference, constant offset
- Modulation frequency of 1 MHz



Demodulation schemes

	Modulation			Demodulation		
Phase	Spin.	Coil	Amplifier output	Sig.	Ref.	Off.
1	+	+	$+(V_{ext} + V_{ref}) + V_{off}$	+	+	+
2	-	+	$-(V_{\text{ext}} + V_{\text{ref}}) + V_{\text{off}}$	1	-	+
3	+	-	$+(V_{\text{ext}} - V_{\text{ref}}) + V_{\text{off}}$	+	-	+
4	-	-	$-(V_{\text{ext}} - V_{\text{ref}}) + V_{\text{off}}$	_	+	+
				4V _{ext}	$4V_{ref}$	$4V_{\rm off}$

- 3 different demodulation schemes
- Offset-free signal & reference demodulation, using synchronous switched-capacitor circuits



Reference signal demodulation

- 2 limitations for precise reference signal extraction:
 - Low reference signal level

•
$$V_{Hall;ref} = (S_{I;Hall} \cdot I_{bias}) \cdot (E_{I;coil} \cdot I_{ref}) = 40 \mu V$$

- $V_{Hall:ref} \cdot 0.1\% = 40 \text{ nV}$
- Input-referred noise = 20 nV/√Hz @ 1 MHz
- External signal aliasing
 - $V_{\text{ext;max}} = 100 \cdot V_{\text{ref}}$
 - High-pass parasitic transfer function
- Solution: Reference signal filtering

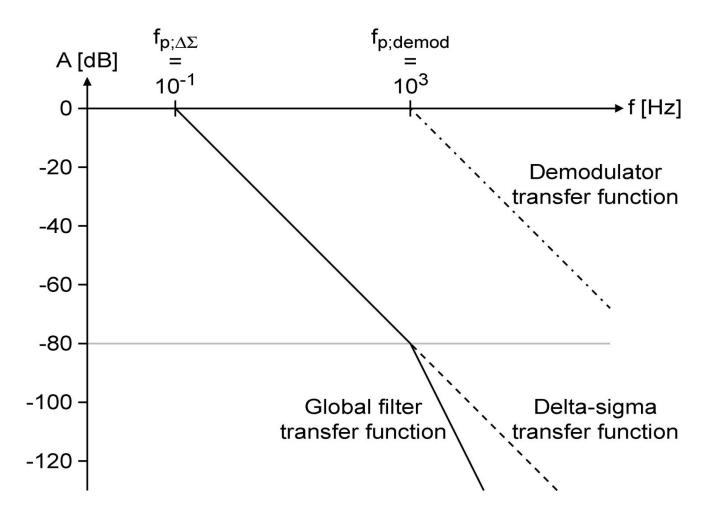


Reference signal filtering

- Filtering combined with reference signal demodulation and analog-to-digital conversion
- Second-order low-pass filtering
- Demodulator pole @ 1 kHz
 - Feedback path in the switched-capacitor demodulator
- Delta-sigma pole @ 0.1 Hz
 - Long integration period



Filtering transfer function





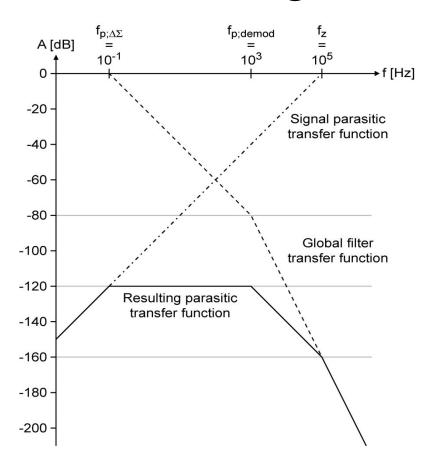
External signal aliasing

$$\begin{split} +[+(V_{ext;1}+V_{ref})+V_{off}] \\ -[-(V_{ext;2}+V_{ref})+V_{off}] \\ -[+(V_{ext;3}-V_{ref})+V_{off}] \\ +[-(V_{ext;4}-V_{ref})+V_{off}] &= 4V_{ref} + \underbrace{[(V_{ext;1}+V_{ext;2})-(V_{ext;3}+V_{ext;4})]}_{Parasitic term} \end{split}$$

- Variation of the external signal between the reference demodulation phases ⇒ alias
- Derivative effect ⇒ high-pass transfer function
- Zero @ 100 kHz



Effect of filtering on alias



Minimum attenuation of 120 dB

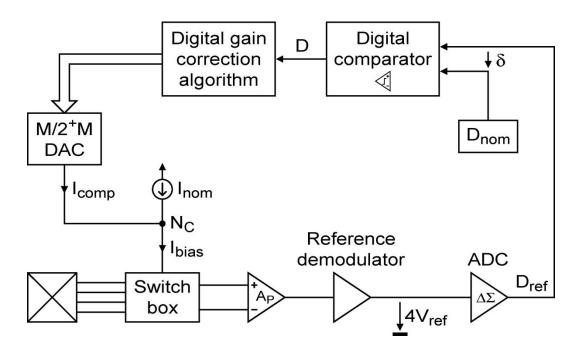


Effects of filtering

- On noise
 - Bandwidth limited to less than 1 Hz
 - White noise integrated in limited bandwidth
 - Total input-referred RMS noise < V_{Hall:ref} · 0.1% = 40 nV
- On aliased external component
 - Minimum attenuation of 120 dB
 - $V_{\text{ext;max}}$ = 100 · V_{ref} attenuated to 100 · V_{ref} / 10⁶ = V_{ref} · 0.01%
- Extraction of $V_{ref} \cdot 0.1\%$ possible \Rightarrow sensitivity calibration with 1'000 ppm accuracy



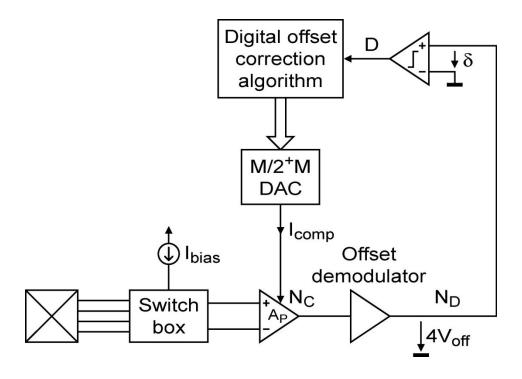
Sensitivity drift compensation



- Sensitivity compensated by sensor bias current adjustment
- $V_{Hall} = (S_{I;Hall} \cdot I_{bias}) \cdot B$



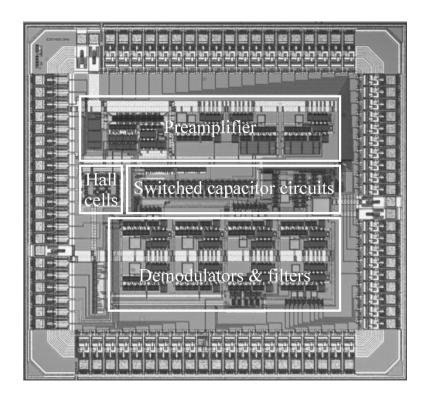
Offset compensation



- Compensation current injection into preamplifier
- Demodulator can be optimized (low-pass filter)



Circuit micrograph



- 11.5 mm² in AMS 0.8 μm CXQ
- Hall sensors & coils integrated



Measurement results

Supply voltage	5 V		
Sensitivity	35 V/T		
Full scale	± 50 mT		
Bandwidth	500 kHz		
Non-linearity	< 0.1 %		
Gain drift	< 50 ppm/°C		

- Compared to state of the art:
 - High bandwidth
 - Low gain drift (6-10 times better)

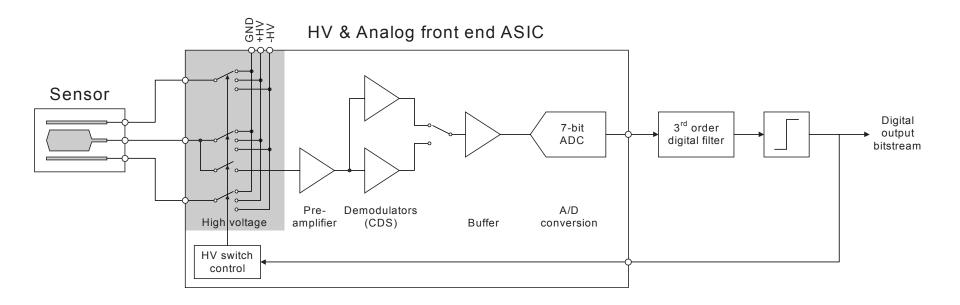


MEMS-based accelerometer

- Closed-loop system
- 5th order ΔΣ loop: Sensor (2nd order) + Filter (3rd order)
- Low-precision front-end (7 bits)
- Internally non-linear ADC
- Digital filter (3rd order)
- Versatile and reconfigurable system, yet featuring high performances

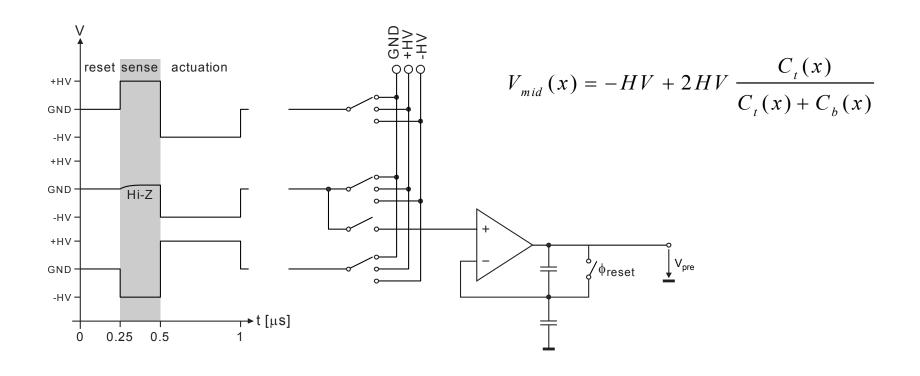


System architecture





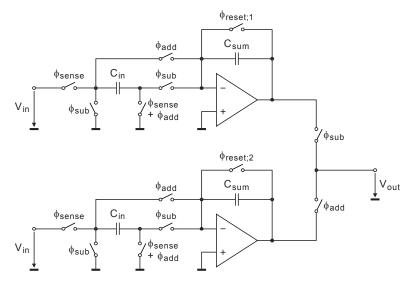
Frontend

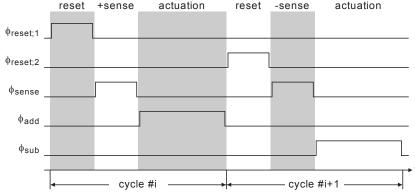


- 11.5 mm² in AMS 0.8 μm CXQ
- Hall sensors & coils integrated



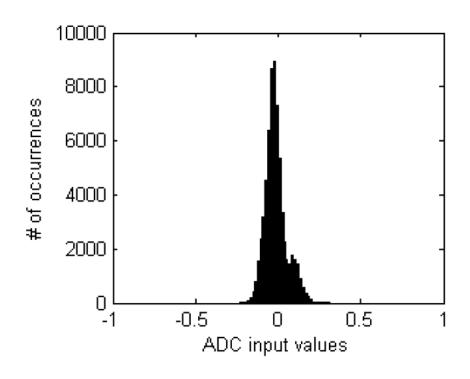
Time-interleaved CDS

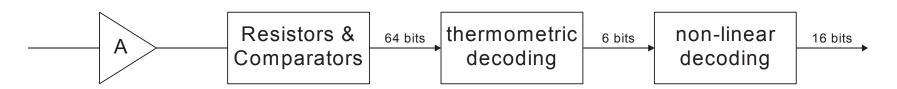






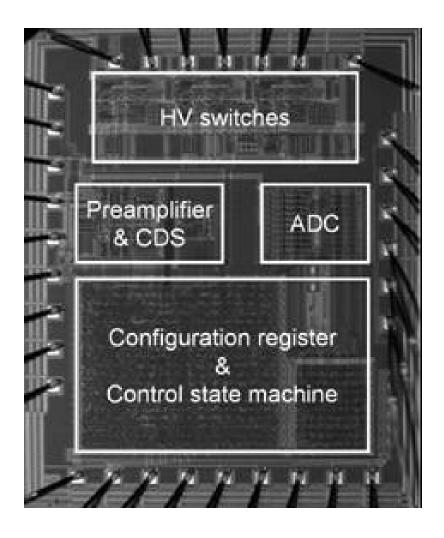
Internally non-linear ADC





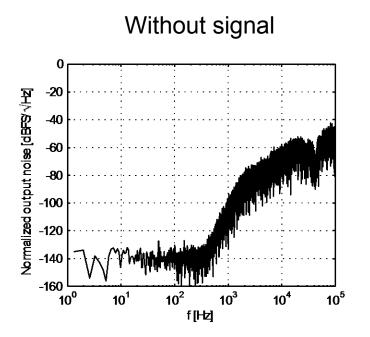


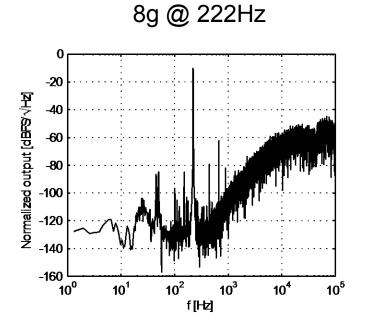
Circuit micrograph





Measurement results





- Compared to state of the art:
 - High bandwidth
 - Low noise



Measurement results

Supply voltage	$3.3V/\pm 9V$
Sampling frequency	1 MHz
$\Delta\Sigma$ loop order	2 + 3 = 5
Full scale	11.7 g
Bandwidth	300 Hz
Input noise	1.7 μg/√Hz
Dynamic range (300 Hz)	19 bits
SNR (300 Hz)	16 bits

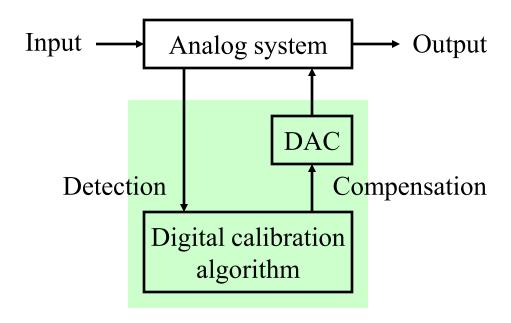


Digital calibration

- Digital compensation of analog circuits
- Successive approximations:
 - Algorithm
 - Working condition
- Sub-binary DACs for successive approximations:
 - Resolution
 - Radix
 - Tolerance to component mismatch
 - Architectures
 - Design



Digital compensation



- High-precision calibration of low-precision circuits
- Alternative to intrinsically precise circuits (matching & high area)



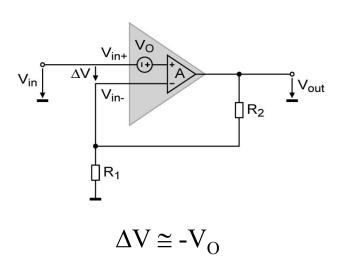
Compensation methodology

- Detection configuration
 - Continuous: normal operation configuration
 - Interrupted: special configuration
- Detection node(s)
 - Imperfection sensing
 - Usually voltage-mode
- Compensation node(s)
 - Imperfection correction
 - Current-mode

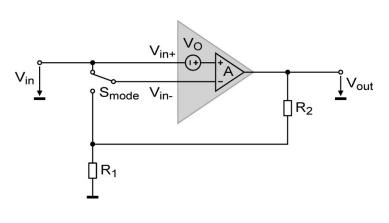


Offset cancellation in OAs

Closed-loop



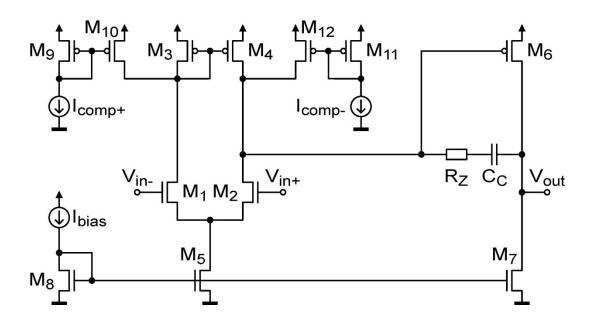
Open-loop



$$V_{out} = AV_O$$

- Closed-loop: calibration during operation possible
- Open-loop: higher detection level

Offset compensation in OAs



- Compensation by current injection
- Unilateral/bilateral
- Compensation current sources: M/2+M DACs

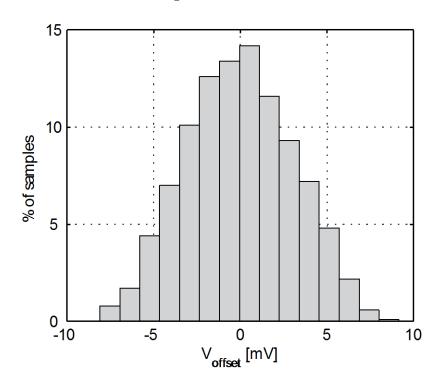


Choice of compensation node(s)

- Compensation current corrects imperfection only
- Current injected by a small current mirror, taking into account:
 - Channel length modulation
 - Saturation voltage
- Connection of the current mirror does not affect the compensation node characteristics:
 - Impedance
 - Parasitic capacitance
 - System parameters linked to parasitics



Offset distribution before compensation



- Gaussian distribution
- Depends on component matching

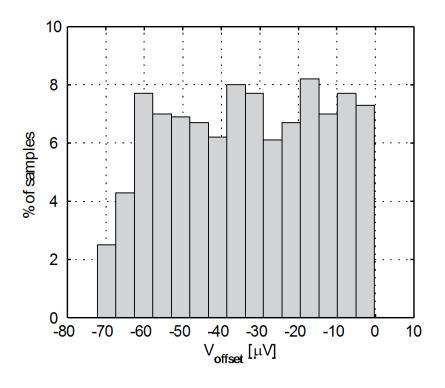


Offset reduction

- Offset can be reduced by:
 - Matching ⇒ Increase area
 - Digital calibration
- Digital calibration circuits can be made very small
- In deep sub-micron technologies:
 - Design analog circuits with reasonable performance
 - Enhance critical parameters by digital calibration
- Mixed-signal solution is optimal in terms of global circuit area



Offset distribution after digital compensation



- Uniform distribution (in a 1 LSB interval)
- Residual offset depends on DAC resolution



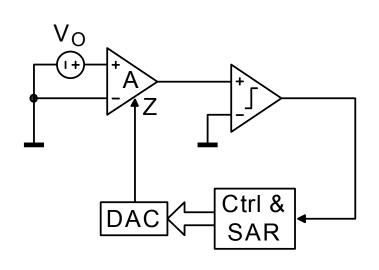
Successive approximations

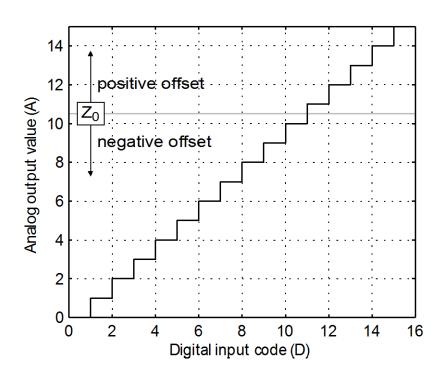
```
reset all d_i = 0
for i = n downto 1
set d_i = 1
if C_{out} > 0
reset d_i = 0
end if
end for
```

- The algorithm decides on the basis of comparisons
- A comparator senses the sign of the imperfection
- Working condition: $b_i \le b_1 + \sum_{j=1}^{i-1} b_j$ (i \in [2, n])



Offset compensation: Target

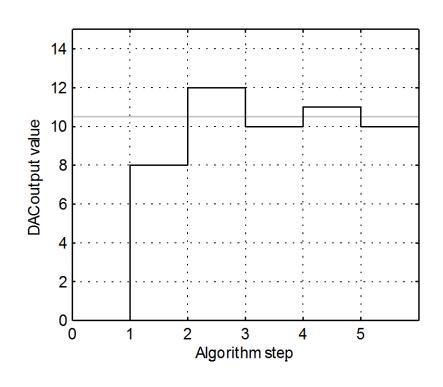




- Z₀: Correction value that perfectly cancels the offset
- A < Z₀: Resulting offset negative
- $A > Z_0$: Resulting offset positive



Offset compensation: Algorithm execution



- From MSB to LSB
- Bit kept if compensation value insufficient



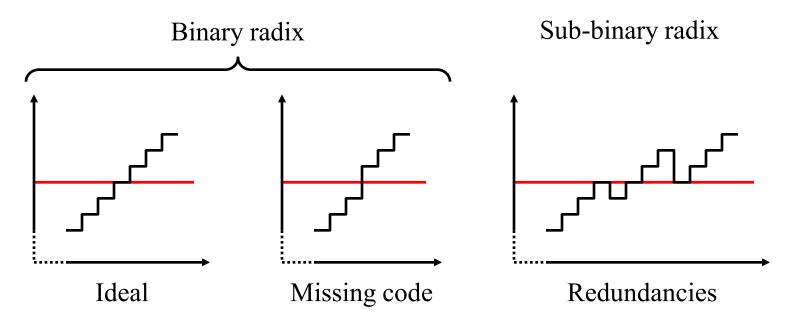
DAC Resolution

$$Resolution = \frac{FullScale}{LSB} \leq \frac{V_{offset ; uncompensa ted ; max}}{V_{offset ; compensate d ; max}}$$

- Full scale chosen to cover whole uncompensated offset range
- Resolution corresponds to residual offset achieved after compensation



DACs for successive approximations



- Imperfections in DACs for compensation
 - Missing codes are problematic
 - Redundancies are acceptable

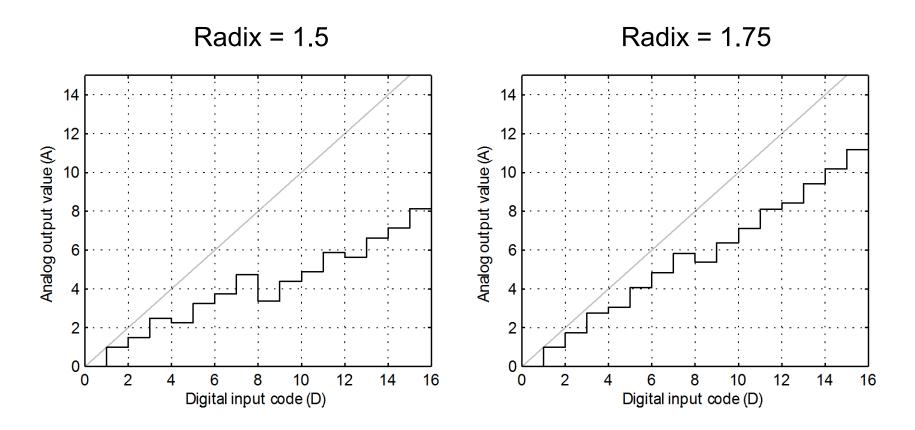


Sub-binary radix DACs

- Code redundancies are voluntarily introduced to:
 - Account for variations of component values
 - Avoid missing codes
- Arbitrarily high resolutions can be achieved without exponential increase of area
- For successive approximations:
 - Precision is not important
 - Resolution is the objective
- Sub-binary DACs are ideal in conjunction with successive approximations
 - Very low area

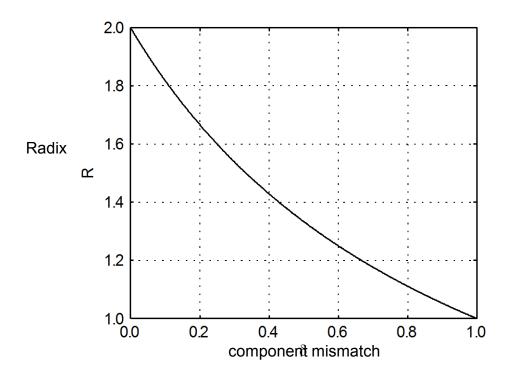


Sub-binary DACs: Radix





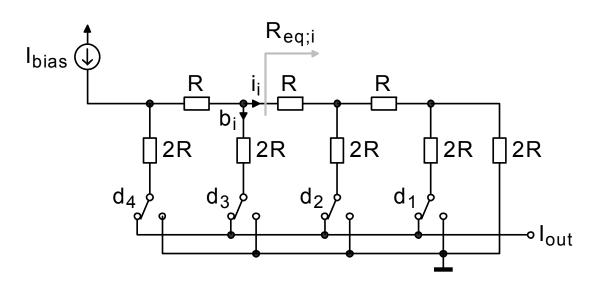
Radix: Tolerance to component mismatch



- Radix-2 tolerates no mismatch!
- 100 % mismatch ⇒ thermometric DAC (radix-1)



Implementation: Current-mode R/2R converters

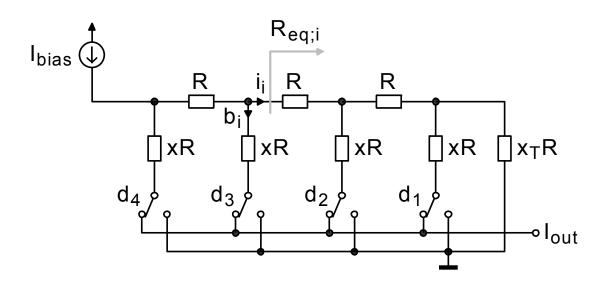


$$b_i = b_1 + \sum_{j=1}^{i-1} b_j$$

- $R_{eq:i} = 2R (\forall i)$
- Current divided equally in each branch (i_i = b_i)
- Component imperfection ⇒ current imbalance ⇒ missing code (or redundancy)



R/2+R converters

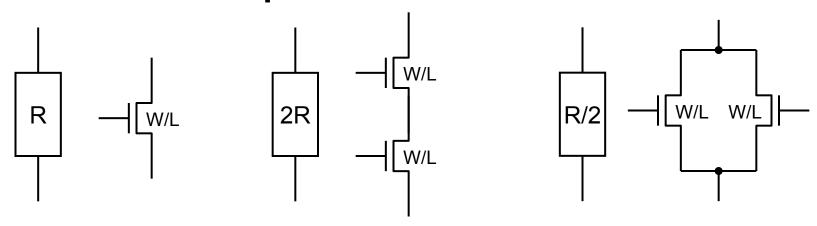


$$b_i < b_1 + \sum_{j=1}^{i-1} b_j$$

- x > 2; $R_{eq;i} < xR$; $i_i > b_i$
- Current division voluntarily unbalanced
 - Radix < 2 (sub-binary)
 - Code redundancies



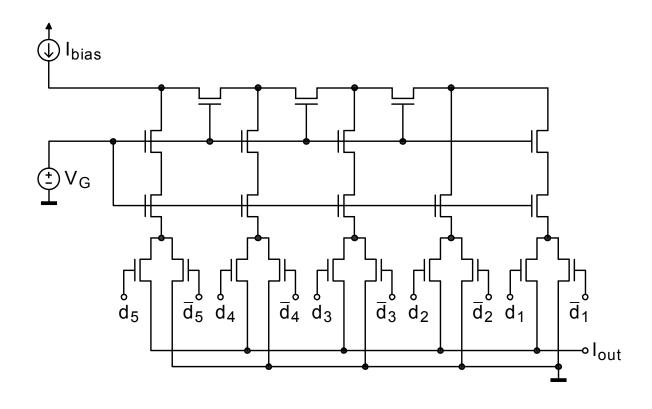
R/2⁺R converters: Pseudo-MOS implementation



- Resistors can advantageously be replaced by transistors to implement the current division
- Unit-size device with fixed W/L implements R
- Unit-size devices are put in series (2R) or in parallel (R/2)
- Unit-size transistors are kept very small
- Condition: V_G identical for all transistors



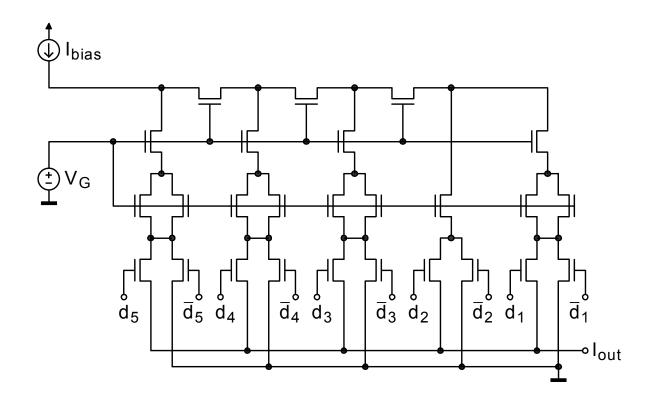
M/3M converters



- Radix 1.77; maximum mismatch 13 %
- V_G = V_{DD} allows driving d_i directly with logic



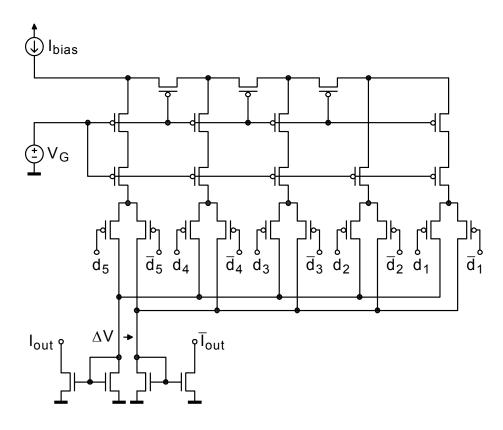
M/2.5M converters



- Radix 1.86; maximum mismatch 7.3 %
- V_G = V_{DD} allows driving d_i directly with logic



Current collectors & Output stage



- Current mirrors simple to implement
- ∆V is not problematic



Conclusion

- Closed-loop systems are less sensitive to imperfections
- Calibration can be included transparently in sampled systems
- It is advantageous to include sensors in $\Delta\Sigma$ loops
- Switched capacitor circuits enable flexible and reconfigurable systems
- Calibration is necessary in deep sub-micron technologies to reach high performances
- Improve analog performance with digital calibration:
 - Design analog circuits with reasonable performance
 - Enhance critical parameters by digital calibration
 - Mixed-signal solution optimal in terms of global circuit area



References

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